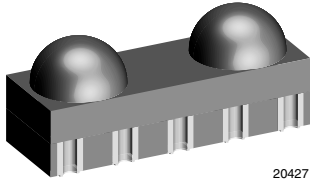


IR Receiver Modules for Remote Control Systems



20427

FEATURES

- Very low supply current
- Photo detectors and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- Capable of side or top view
- Two lenses for high sensitivity and wide receiving angle
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- Insensitive to supply voltage ripple and noise



DESCRIPTION

The TSOP853.. - series are two lens miniaturized receiver modules for infrared remote control systems. One PIN diode per lens and a preamplifier are assembled on a PCB, the epoxy lens cap is designed as an IR filter.

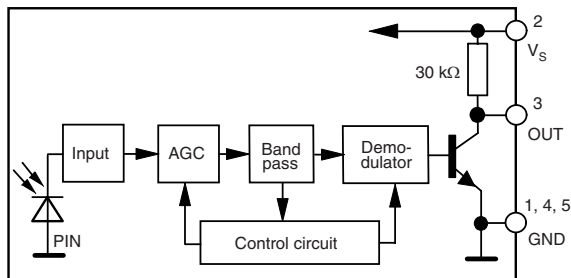
The demodulated output signal can be directly decoded by a microprocessor. The TSOP853.. is optimized to better suppress spurious pulses from energy saving fluorescent lamps but will also suppress some data signals.

This component has not been qualified according to automotive specifications.

PARTS TABLE

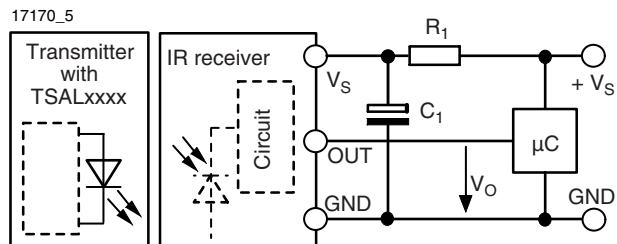
| CARRIER FREQUENCY | NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3) |
|-------------------|--|
| 30 kHz | TSOP85330 |
| 33 kHz | TSOP85333 |
| 36 kHz | TSOP85336 |
| 38 kHz | TSOP85338 |
| 40 kHz | TSOP85340 |
| 56 kHz | TSOP85356 |

BLOCK DIAGRAM



20445

APPLICATION CIRCUIT



R_1 and C_1 are recommended for protection against EOS. Components should be in the range of $33 \Omega < R_1 < 1 \text{ k}\Omega$, $C_1 > 0.1 \mu\text{F}$.



| ABSOLUTE MAXIMUM RATINGS (1) | | | | |
|------------------------------|------------------------------|-----------|--------------------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Supply voltage | | V_S | - 0.3 to + 6.0 | V |
| Supply current | | I_S | 3 | mA |
| Output voltage | | V_O | - 0.3 to ($V_S + 0.3$) | V |
| Output current | | I_O | 5 | mA |
| Junction temperature | | T_j | 100 | °C |
| Storage temperature range | | T_{stg} | - 25 to + 85 | °C |
| Operating temperature range | | T_{amb} | - 25 to + 85 | °C |
| Power consumption | $T_{amb} \leq 85 \text{ °C}$ | P_{tot} | 10 | mW |
| Soldering temperature | | T_{sd} | 260 | °C |

Note

(1) Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

| ELECTRICAL AND OPTICAL CHARACTERISTICS (1) | | | | | | |
|--|---|--------------------|------|----------|------|-------------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply voltage | | V_S | 2.5 | | 5.5 | V |
| Supply current | $V_S = 3.3 \text{ V}, E_v = 0$ | I_{SD} | 0.27 | 0.35 | 0.45 | mA |
| | $E_v = 40 \text{ klx, sunlight}$ | I_{SH} | | 0.45 | | mA |
| Transmission distance | $E_v = 0, \text{ IR diode TSAL6200, } I_F = 250 \text{ mA, test signal see fig. 1}$ | d | | 45 | | m |
| Output voltage low | $I_{OSL} = 0.5 \text{ mA, } E_e = 0.7 \text{ mW/m}^2, \text{ test signal see fig. 1}$ | V_{OSL} | | | 100 | mV |
| Minimum irradiance | Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_0,$ test signal see fig. 1 | $E_e \text{ min.}$ | | 0.1 | 0.25 | mW/m ² |
| Maximum irradiance | $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 6/f_0,$ test signal see fig. 1 | $E_e \text{ max.}$ | 30 | | | W/m ² |
| Directivity | Angle of half transmission distance | $\phi_{1/2}$ | | ± 50 | | deg |

Note

(1) $T_{amb} = 25 \text{ °C}$, unless otherwise specified

TYPICAL CHARACTERISTICS

$T_{amb} = 25 \text{ °C}$, unless otherwise specified

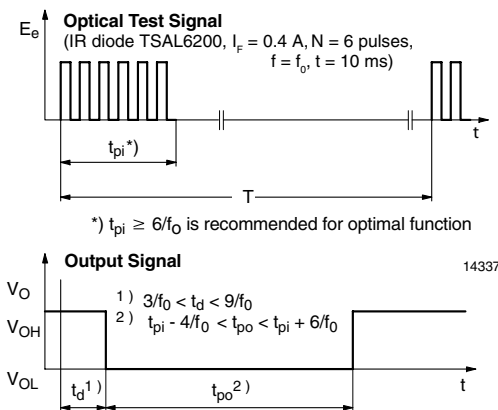


Fig. 1 - Output Active Low

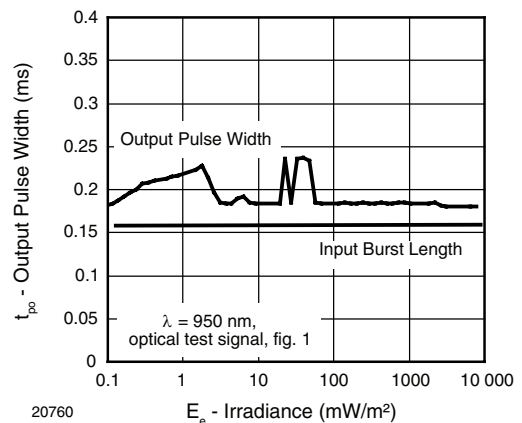


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

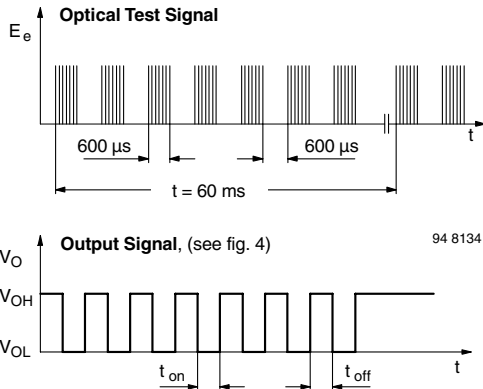


Fig. 3 - Output Function

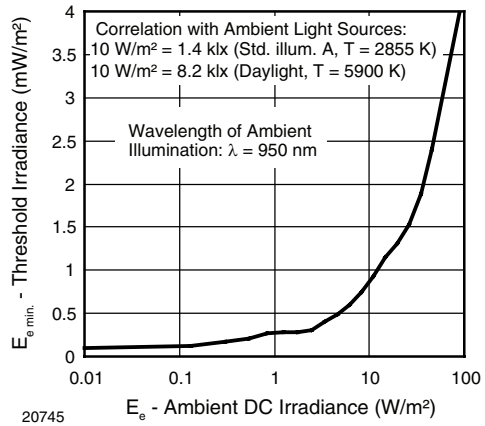


Fig. 6 - Sensitivity in Bright Ambient

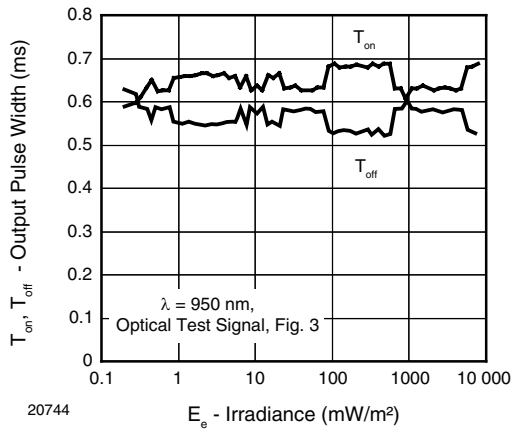


Fig. 4 - Output Pulse Diagram

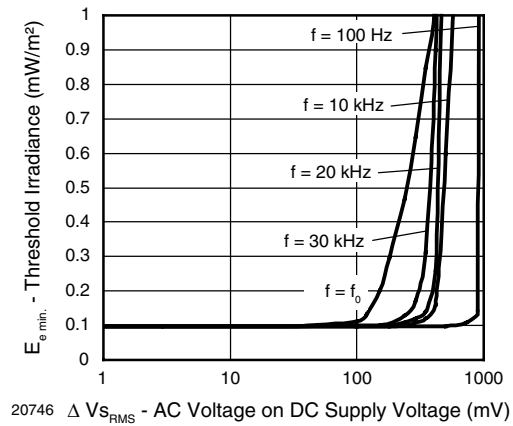


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

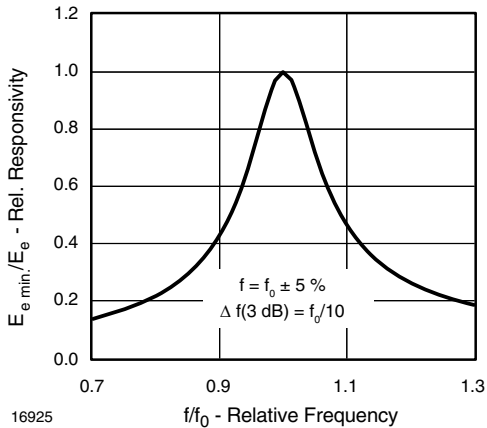


Fig. 5 - Frequency Dependence of Responsivity

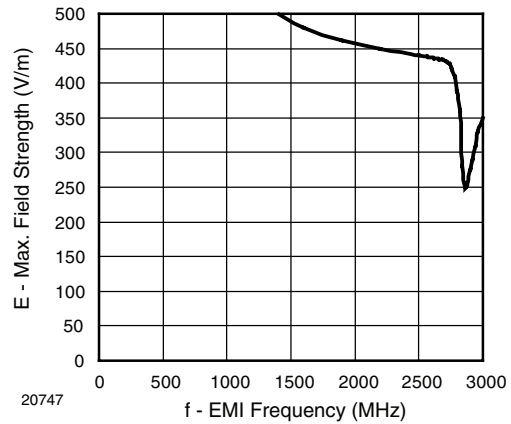


Fig. 8 - Sensitivity vs. Electric Field Disturbances

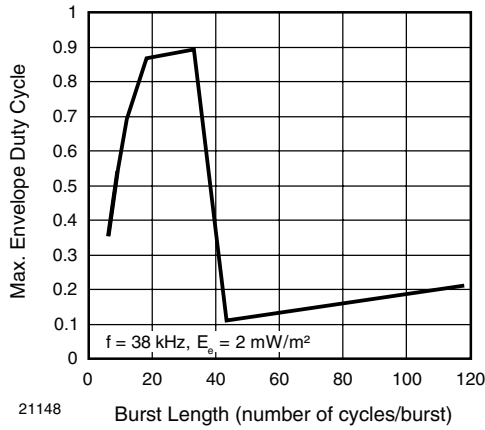


Fig. 9 - Maximal Envelope Duty Cycle vs. Burst Length

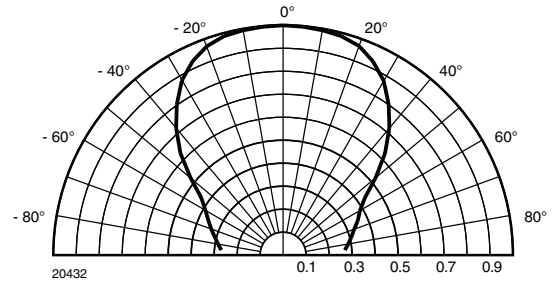


Fig. 12 - Directivity

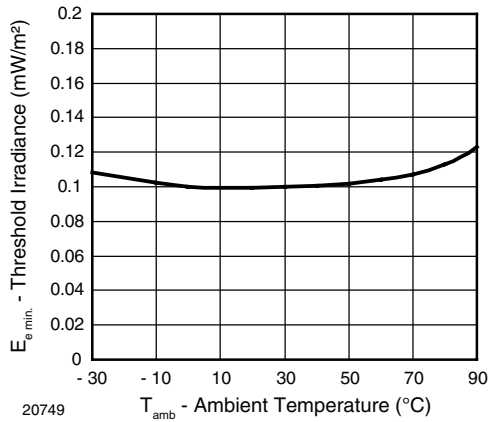


Fig. 10 - Sensitivity vs. Ambient Temperature

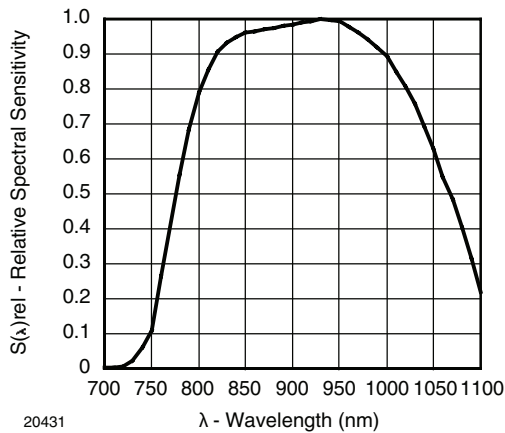


Fig. 11 - Relative Spectral Sensitivity vs. Wavelength

SUITABLE DATA FORMAT

The TSOP853.. series is designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP853.. in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- Continuous signals at any frequency
- Modulated noise from fluorescent lamps with electronic ballasts

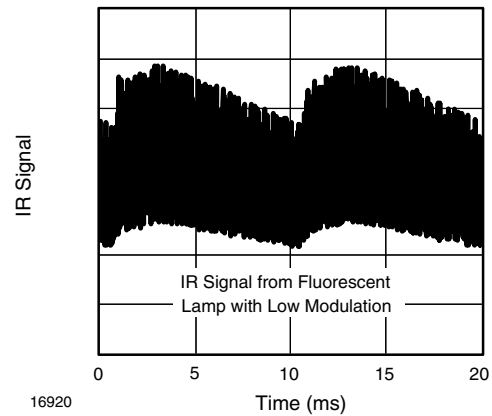


Fig. 13 - IR Signal from Fluorescent Lamp with Low Modulation

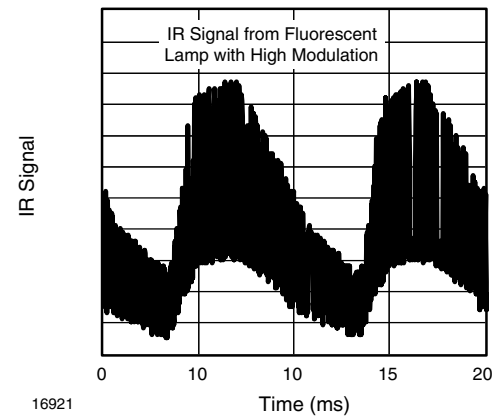
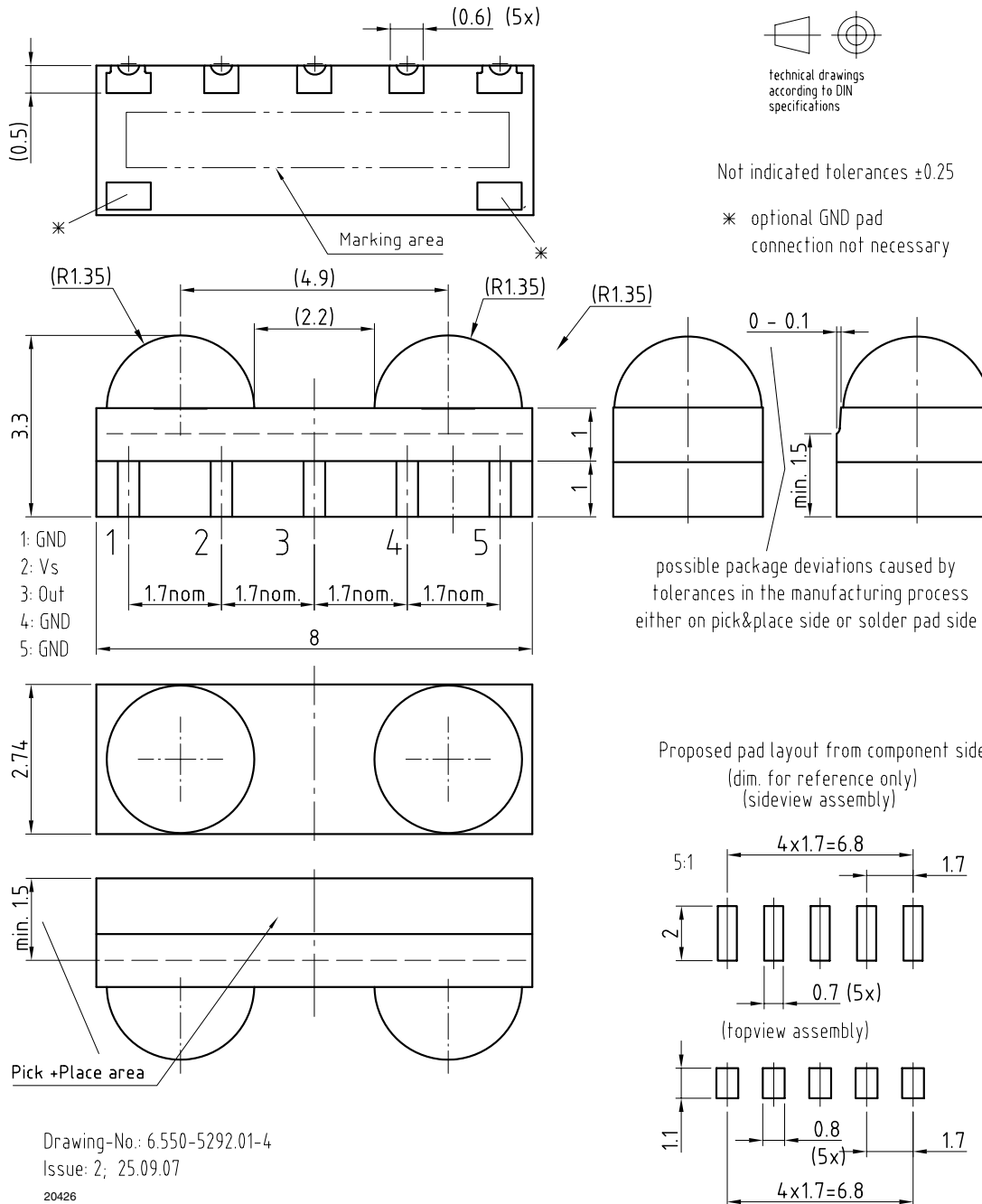


Fig. 14 - IR Signal from Fluorescent Lamp with High Modulation

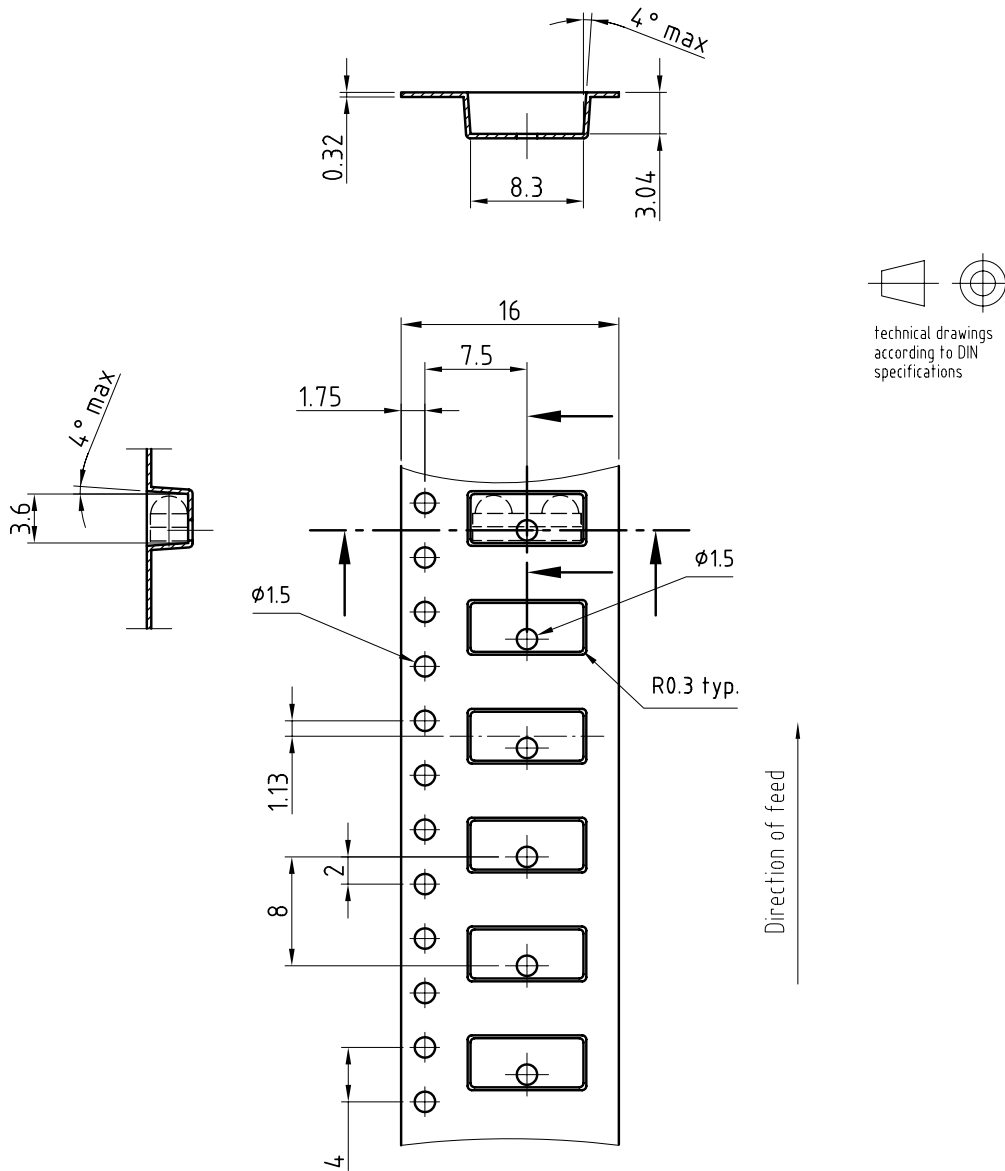
| | TSOP853.. |
|--|--|
| Minimum burst length | 6 cycles/burst |
| After each burst of length a minimum gap time is required of | 6 to 35 cycles ≥ 10 cycles |
| For bursts greater than a minimum gap time in the data stream is needed of | 35 cycles > 6 x burst length |
| Maximum number of continuous short bursts/second | 2000 |
| Compatible to NEC code | yes |
| Compatible to RC5/RC6 code | yes |
| Compatible to Sony code | no |
| Compatible to RCMM code | yes |
| Compatible to r-step code) | yes |
| Compatible to XMP code | yes |
| Suppression of interference from fluorescent lamps | Even critical disturbance signals are suppressed (examples: signal pattern of fig. 13 and fig. 14) |

Note

For data formats with long bursts (more than 10 carrier cycles) please see the data sheet for TSOP852..., TSOP854..

PACKAGE DIMENSIONS in millimeters


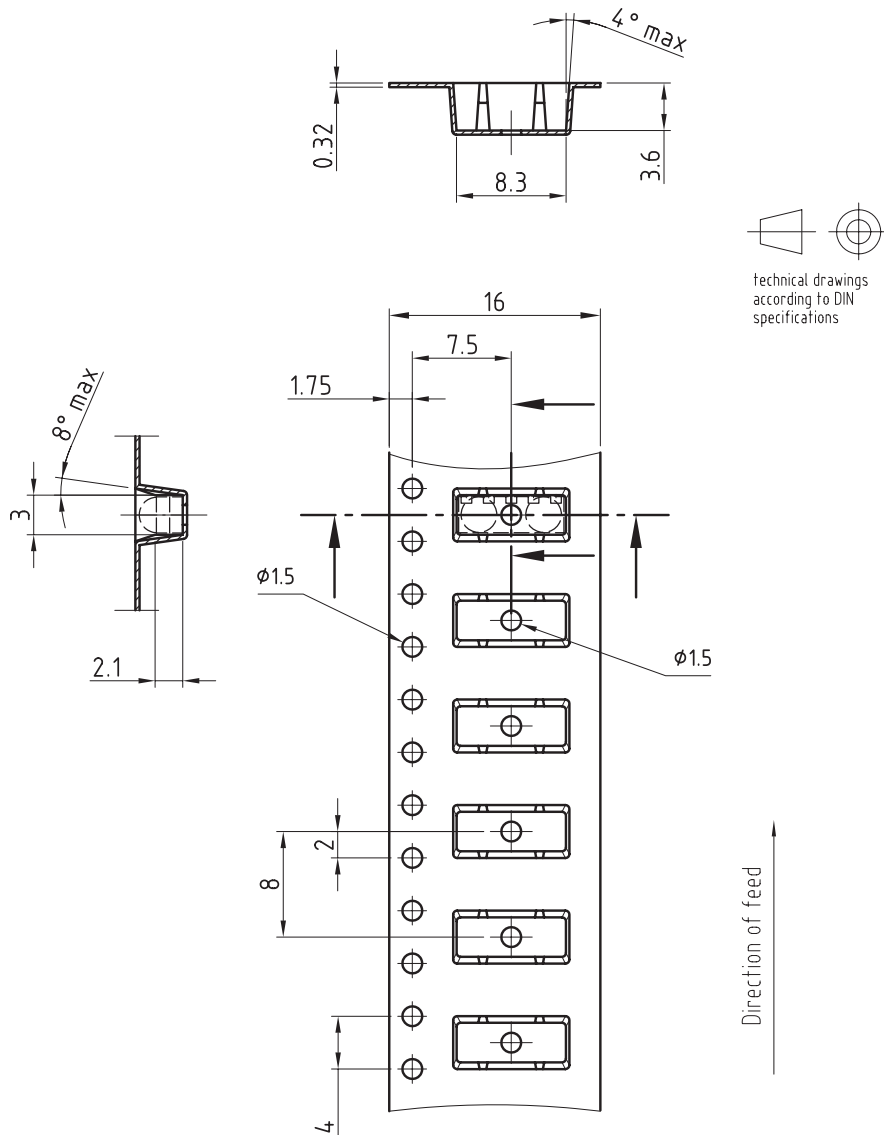
TAPING VERSION TSOP..TR Dimensions in millimeters



Drawing-No.: 9.700-5316.01-4

Issue: 1; 12.02.07

20628

TAPING VERSION TSOP..TT Dimensions in millimeters


Drawing-No.: 9.700-5317.01-4

Issue: 2; 10.04.08

20629



OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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